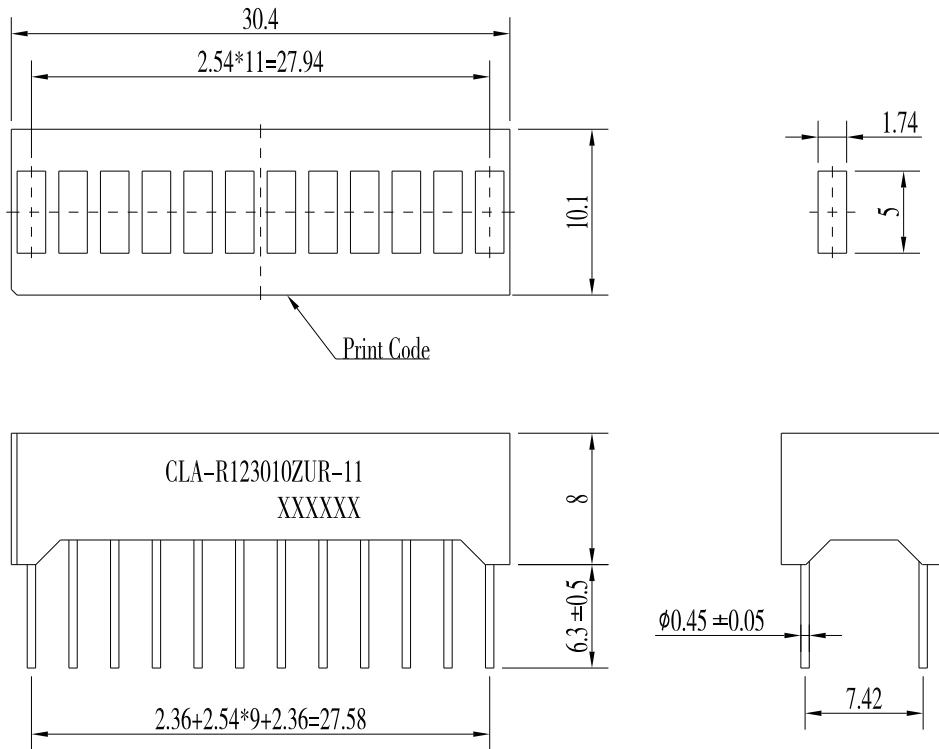


### Descriptions

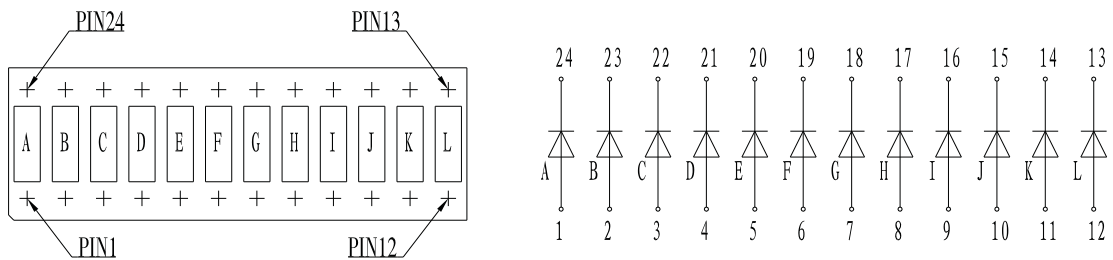
1. Emitting Color: Ultra Red
2. Lens Color: White Diffuse
3. Surface Black Color : Black
4. Dice Material: AlGaInP/GaAs

### Outline Drawing



Tolerance is  $\pm 0.25$ mm unless otherwise noted, Unit=mm  
Pin bending  $\leq$  length\*1%

### Internal Circuit Diagram



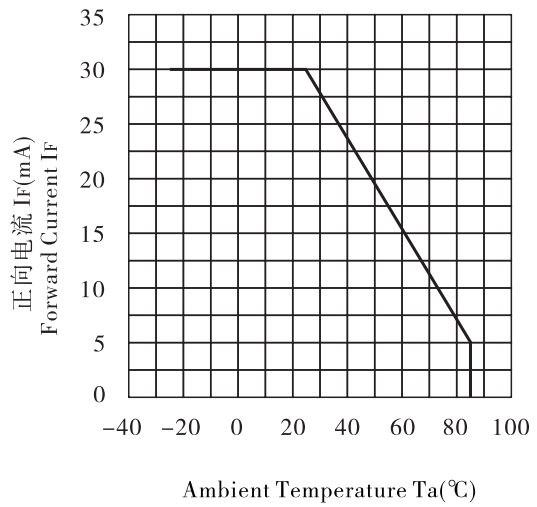
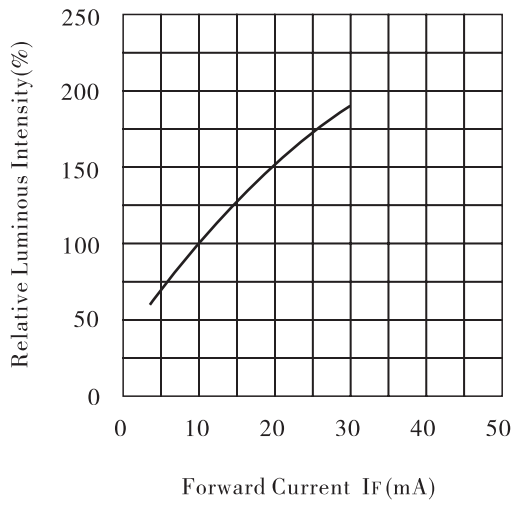
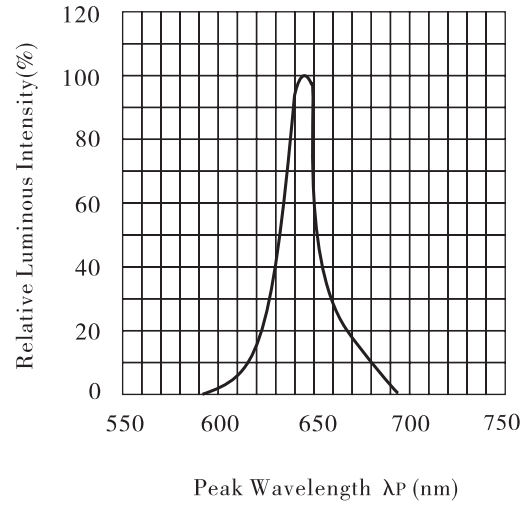
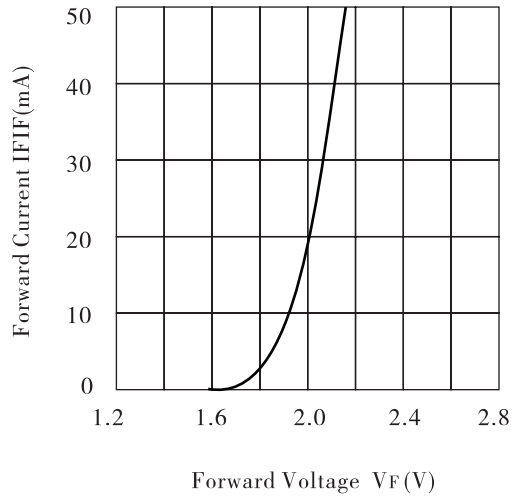
Electrical Optical Characteristics(Ta=25°C)

Parameter	Symbol	Ultra Red			Unit	Test Condition
		Min	Typ	Max		
Forward Voltage	V <sub>F</sub>	---	2.0	2.4	V	IF=20mA
Luminous Intensity	I <sub>V</sub>	5.0	9.8	---	mcd	IF=10mA
Peak Wavelength	λ <sub>P</sub>	---	645	---	nm	IF=20mA
Dominant Wavelength	λ <sub>d</sub>	---	635	---	nm	IF=20mA
Spectral Line half-width	Δλ	---	20	---	nm	IF=20mA
Reverse Leakage Current	I <sub>R</sub>	---	---	50	μA	VR=5V

Absolute Maximum Parameters(Ta=25°C)

Parameter	Symbol	Condition	Rating	Unit
Power Dissipation	P <sub>D</sub>	---	80	mW
Reverse Voltage	V <sub>R</sub>	---	5	V
Forward Average Current	I <sub>F</sub>	---	30	mA
Temperature Coefficient	I/C	---	0.33	mA/ °C
Pulse Current	I <sub>FP</sub>	Duty=1/10,1kHz	100	mA
Operating Temperature Range	T <sub>opr</sub>	---	-25 ~ +85	°C
Storage Temperature Range	T <sub>stg</sub>	---	-30 ~ +100	°C
Soldering Condition	T <sub>sd</sub>	---	260/5sec	°C

Typical Electro/Optical Characteristic Curves(Ta=25°C)



### Reliability Test Conditions

Test Item	Test Condition	Result	Judgment Criteria
Consecutive operating life test	IF=20mA, T=25℃, t=168h	0/10	Forward Voltage $VF(V) = \text{Upper Limit} \times 1.2$ Reverse Leakage Current $IR(\mu A) = \text{Upper Limit} \times 2.0$ Luminous Intensity IV $(mcd) = \text{Lower Limit} \times 0.7$
High temperature storage life test	T=100℃, t=168h	0/10	
Low temperature storage life test	T=25℃, t=168h	0/10	
High temperature humidity storage life test	T=85 ± 2℃, RH=85% ± 3, t=168h	0/10	
Temperature cycle test	-25℃~25℃~100℃ 30min 5min 30min 10cycles	0/10	
Thermal shock test	100℃ 0℃ 5min 5min 20cycles	0/10	
Soldering heat test	T=260 ± 5℃, t=10s ± 1s	0/10	
Solderability test	T=235 ± 5℃, t=5s ± 0.5s	0/10	Steeped Part ≥ 95%
Fall test	h=100cm, 50times	0/10	Surface Appearance Photoelectric Properties Intact
Terminal strength test	W=9.8N, t=30 ± 5s	0/10	
Lead bending test	W=4.9N, 2times	0/10	